



**THE DATASHEET OF
SN74S157DG4**



SN54157, SN54LS157, SN54S157, SN54LS158, SN54S158, SN74157, SN74LS157, SN74S157, SN74LS158, SN74S158
 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

MARCH 1974 - REVISE: J MARCH 1988

- Buffered Inputs and Outputs
- Three Speed/Power Ranges Available

TYPES	TYPICAL AVERAGE PROPAGATION TIME	TYPICAL POWER DISSIPATION
'157	9 ns	110mW
'LS157	9 ns	49mW
'S157	5 ns	250mW
'LS158	7 ns	24mW
'S158		195mW

applications

- Expand Any Data Input Point
- Multiplex Dual Data Buses
- Generate Four Functions of Two Variables (One Variable Is Common)
- Source Programmable Counters

description

These monolithic data selectors/multiplexers contain inverters and drivers to supply full on-chip data selection to the four output gates. A separate strobe input is provided. A 4-bit word is selected from one of two sources and is routed to the four outputs. The '157, 'LS157, and 'S157 present true data whereas the 'LS158 and 'S158 present inverted data to minimize propagation delay time.

FUNCTION TABLE

STROBE G	INPUTS			OUTPUT Y	
	SELECT A/B	A	B	'157 'LS157 'S157	'LS158 'S158
X	X	X	X	L	H
L	L	L	X	L	H
L	L	H	X	H	L
H	X	L	X	L	H
H	X	H	X	H	L

H = high level, L = low level, X = irrelevant

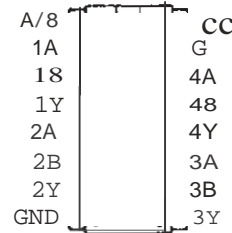
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage: V _{ee} (See Note 1)	7V
Input voltage: '157, 'S158	5.5 V
'LS157, 'LS158	7 V
Operating free-air temperature range: SN54'	-55°C to 125°C
SN74'	0°C to 70°C
Storage temperature range	-65°C to 150°C

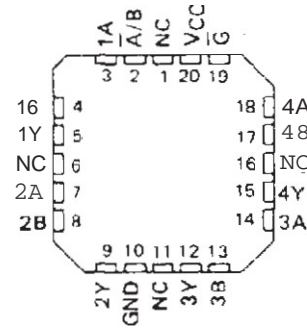
NOTE 1: Voltage values are with respect to network ground terminal.

SN54157, SN54LS157, SN54S157,
 SN54158, SN54LS158, SN54S158 ... J OR W PACKAGE
 SN74157 ... N PACKAGE
 SN74LS157, SN74S157,
 SN74158, SN74LS158 ... D OR N PACKAGE

TOP VIEW



SN54157, SN54S157, SN54LS158, SN54S158 ... FK PACKAGE (TOP VIEW)



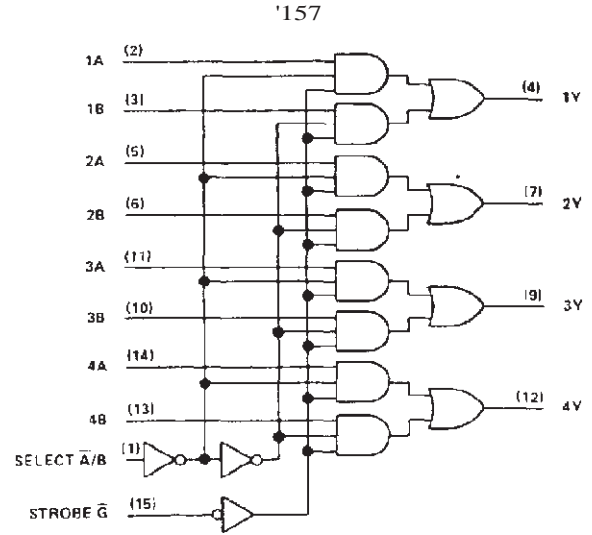
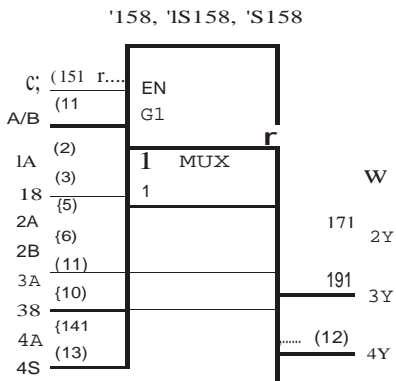
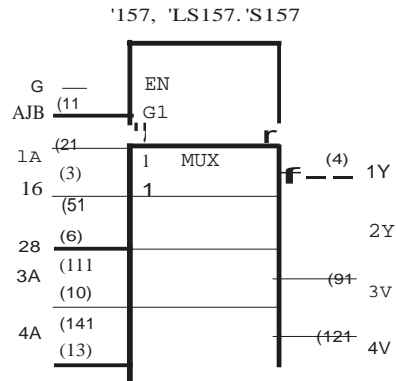
NC - No internal connection

PROVIDE DATA ...
 current of ...
 OF ...
 ...
 ne ...

SN54157, SN54LS157, SN54LS158, SN54S157, SN54S158,
 SN74157, SN74LS157, SN74S157, SN74S158
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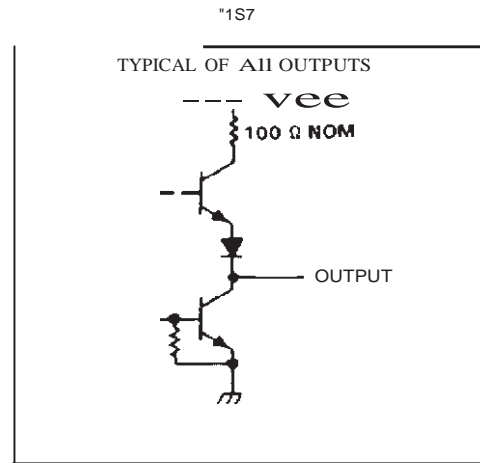
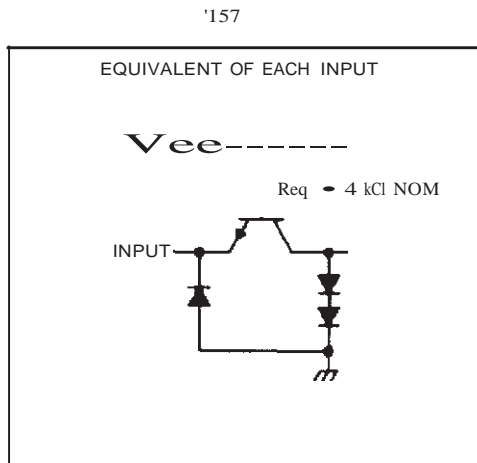
logic symbols'

logic diagram (positive logic)



These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

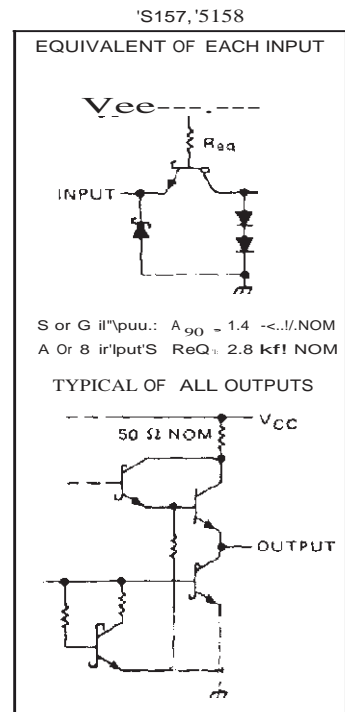
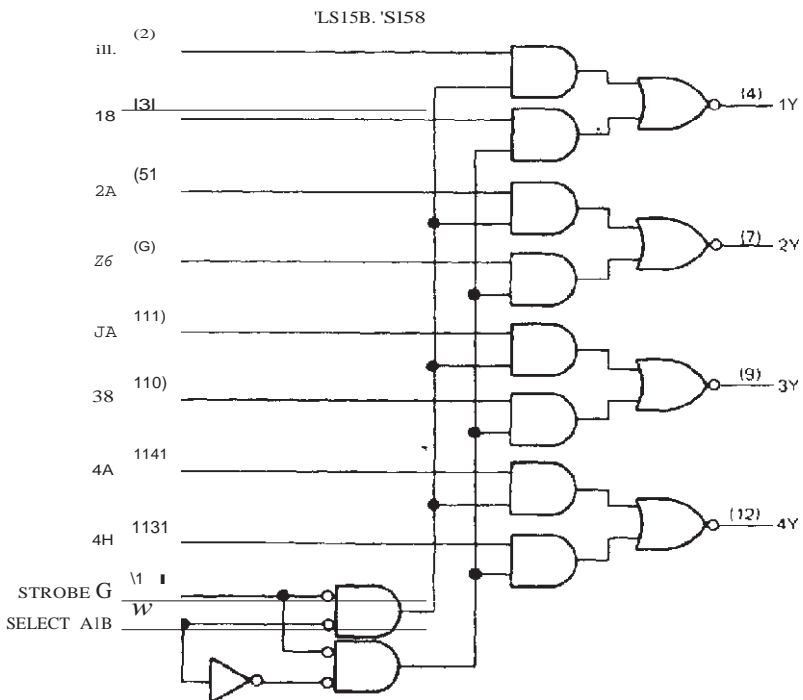
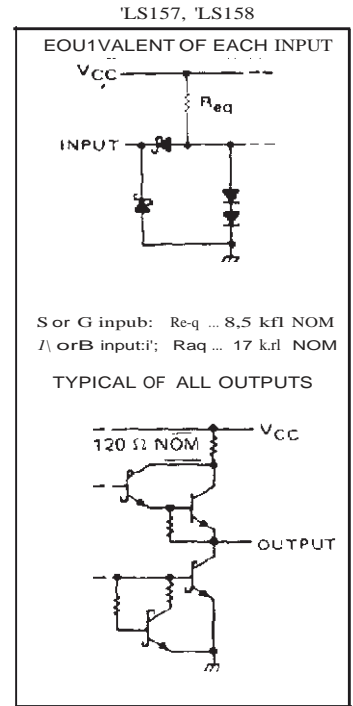
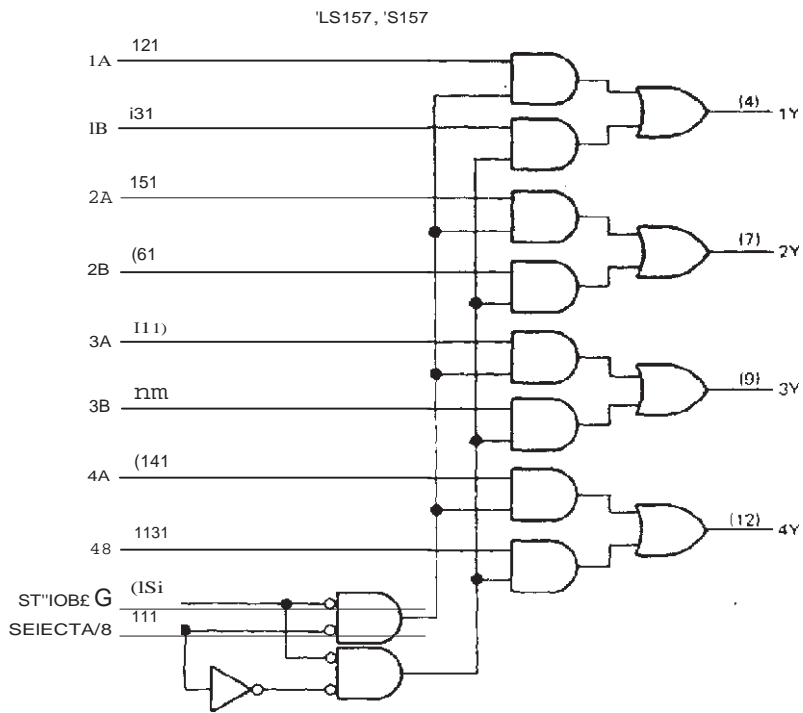
schematics of inputs and outputs



SN54LS157, SN54LS158, SN54S157, SN54S158,
 SN74LS157, SN74LS158, SN74S157, SN74S158
 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

logic diagrams (positive logic)

schematics of inputs and outputs



Pin numbers shown are for D, J, N, and W packages.

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SN54157, SN74157
 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

recommended operating conditions

	SN54157			SN74157			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{EE}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}	-BOO			-800			mA
Low-level output current, I_{OL}	16			16			mA
Operating free air temperature, T_A	-55			125			$^{\circ}C$

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS ¹	SN 54157		SN 74157		UNIT
		MIN	TYP: MAX	MIN	TYP: MAX	
High-level input voltage		2		2		V
V_{IH} Low-level input voltage		0.8		0.8		V
V_{IK} Input clamp voltage	$V_{EE} \text{ MIN, } I_I = 12 \text{ mA}$	1.5		1.5		V
V_{OH} High-level output voltage	$V_{EE} \text{ MIN, } V_{IH} = 2 \text{ V, } V_{IL} = 0.8 \text{ V, } I_{OH} = -800 \mu\text{A}$	2.4	3.4	2.4	3.4	V
V_{OL} Low-level output voltage	$V_{EE} \text{ MIN, } V_{IH} = 2 \text{ V, } V_{IL} = 0.8 \text{ V, } I_{OL} = 16 \text{ mA}$	0.2		0.2		V
I_{IH} Input current at minimum input voltage	$V_{EE} \text{ MAX, } V_I = 5.5 \text{ V}$	40		40		mA
I_{IL} High-level input current	$V_{EE} \text{ MAX, } V_I = 2.4 \text{ V}$	1.6		1.6		mA
I_{CC} Short-circuit output current	$V_{EE} \text{ MAX}$	-20	-55	-18	55	mA
I_{CC} Supply current	$V_{EE} \text{ MAX, See Note 2}$	30		48		mA

¹ For condition-f, shown as MIN or MAX, use the appropriate value specified under recommended operating condition. All typical values are at $V_{EE} = 5 \text{ V, } T_A = 25^{\circ}C$.

Not more than one output should be shorted at a time and duration of short-circuit should not exceed one second.

NOTE 2: I_{CC} measured at $V_{EE} = 4.5 \text{ V}$ applied 10 H input, and all outputs open.

switching characteristics, $V_{EE} = 5 \text{ V, } T_A = 25^{\circ}C$

PARAMETER	FROM (INPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Data	$C_L = 10 \text{ pF, } R_1 = 400 \Omega, \text{ See Note 3}$	9		14	s
t_{PHL}			9		14	
t_{PLH}	Strobe G		11		20	s
t_{PHL}			14		21	
t_{PLH}	Select A:B		15		23	ns
t_{PHL}			18		27	

t_{PLH} = propagation delay time, low-to-high level output

t_{PHL} = propagation delay time, high-to-low level output

NOTE 3: load circuits and voltage waveforms as shown in Section 1

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SN54LS157, SN54LS158, SN74LS157, SN74LS158
 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

recommended operating conditions

	SN54LS ¹			SN74LS ¹			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{ee} Supply-PIV voltage	4.5	5	5.5	4.75	5	5.25	V
I _{OH} High-level output current			-400			-400	>I _A
I _{QL} Low-level output current			4			8	mA
T _A Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS ¹	SN54LS ¹		SN74LS ¹		UNIT			
		MIN	TYP ²	MAX	MIN		TYP ²	MAX	
V _{IH} High-level input voltage		2			2	V			
V _{IL} Low-level input voltage			0.7			0.8	V		
V _{IK} Input clamp voltage	V _{ee} MIN, I _t = 18mA			-1.5		-1.5	V		
V _{OH} High-level output voltage	V _{ee} MIN, V _{tH} 2V, V _{tL} MAX, I _{OH} -400µA	2.5	3.4		2.7	3.4	V		
V _{OL} Low-level output voltage	V _{ee} MIN, V _{tH} 2V, I _{OL} 4mA, V _{tL} MAX, I _{tot} = 8mA		0.25	0.4		0.25	0.4	V	
I _I Input current at maximum input voltage	A/B or G			0.2			0.2	mA	
	A or B	V _{ee} MAX, V _I = 7V				0.1		0.1	
I _{tH} High-level input current	A/B or G			40			40	µA	
	A or B	V _{ee} MAX, V _I = 2.1V				20		20	
I _{tL} Low-level input current	A/B or G			-0.8			-0.8	mA	
	A or B	V _{ee} = MAX, V _I = 0.4V				-0.4		-0.4	
I _{OS} Short-circuit output current ³	V _{ee} MAX	-20		-100		-20		mA	
I _{see} Supply Current ¹	V _{ee} MAX, See Note		'LS157	9.7	16		9.7	16	mA
			'S158	4.8	8		4.8	8	
	V _{ee} MAX, All A inputs at 4.5V, All other inputs at 0V		'S158	6.5	11		6.5	11	

¹ For conditions 1 through 5, see Note 1. MIN or MAX. unless otherwise specified, are specified under recommended operating conditions.
² All typical values are at V_{CC} = 5V, T_A = 25°C.
³ Not more than one output should be driven to a time and duration of short circuit should not exceed 100µs.
 NOTE 2: I_{CC} is measured with 4.5V applied to all inputs and all outputs open.

switching characteristics, V_{ee} = 5V, T_A = 25°C

PARAMETER	FROM (INPUT)	TEST CONDITIONS	'LS157			'LS156			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
t _{PLH}	Data	CL 15pF, RL = 2kΩ, See Note 3	9	14		7	12	ns	
t _{PHL}			9	14		10	15		
t _{PLH}	Strobe G		13	20		11	17	ns	
t _{PHL}			14	21		18	24		
t _{PIH}	Select A/B		15	23		13		ns	
t _{PHL}			18	27		16	2		

t_{PLH} = propagation delay time, low-to-high-level output

t_{PHL} = propagation delay time, high-to-low-level output

NOTE 3: Load circuit and voltage diagrams are shown in Section 1

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SN54S157, SN54S158, SN74S157, SN74S158
 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

recommended operating conditions

	SN54S157			SN74S157			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{EE}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{QH}			-1			-1	mA
Low-level output current, I_{OL}			20			20	mA
Operating free-air temperature, T_A	-55		125	0		70	C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	SN54S157		SN54S158		UNIT	
		MIN	TYP	MAX	MIN		TYP
v_{IH} High-level input voltage		2			2	V	
v_{IL} Low-level input voltage				0.8		0.8	V
v_{IK} Input clamp voltage	$V_{EE} \text{ MIN. } I_t = -18 \text{ mA}$			-1.2		-1.2	V
V_{OH} High-level output voltage	$V_{EE} = \text{MIN. } V_{IH} = 2 \text{ V, } I_{S} = 1 \text{ S}$	2.5	3.4	2.5	3.4	V	
	$V_{tL} = 0.8 \text{ V, } I_{OH} = -1 \text{ mA } I_{S} \leq 74 \text{ S}$	2.7	3.4	2.7	3.4		
V_{OL} Low-level output voltage	$V_{EE} \text{ MIN. } V_{tH} = 2 \text{ V, } V_{tL} = 0.8 \text{ V, } I_{OL} = 20 \text{ mA}$			0.5		0.5	V
I_{iL} Input current at maximum input voltage	$V_{EE} = \text{MAX. } V_t = .5 \text{ V}$			1		1	mA
I_{tH} High-level input current	A or B			100		100	A
	A or B			50		50	
I_{iL} Low-level input current	A or B			-4		-4	mA
	A or B			-2		-2	
I_{OS} Short-circuit output current	$V_{EE} = \text{MAX}$	40	100	-10	-100	mA	
	$V_{EE} = \text{MAX. All inputs } 1.4 \text{ V.}$						
I_{EE} Supply current	See Note 2	50	78	39	61	mA	
	$V_{EE} = \text{MAX, A inputs at } 4.5 \text{ V.}$						81

† B, G, S, input < at 0 V. See Note 2

For conditions, see MIN or MAX, use the typical values at $V_{CC} = 5 \text{ V, } T_A = 25^\circ \text{C}$.

NOTE 1: Typical values are at $V_{CC} = 5 \text{ V, } T_A = 25^\circ \text{C}$.

NOTE 2: More than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: I_{CC} is measured with all outputs open.

switching characteristics, $V_{EE} = 5 \text{ V, } T_A = 25^\circ \text{C}$

PARAMETER	FROM (INPUT)	TEST CONDITIONS	SN54S157		SN54S158		UNIT
			MIN	TYP	MAX	MIN	
t_{PLH}	Data	CL = 151-pf, RL = 2B011, See Note 3	5	7.5	4	6	ns
t_{PHL}	Data		4.5	6.5	4	6	
t_{PLH}	Strobe G		8.5	12.5	6.5	11.5	ns
t_{PHL}	Strobe G		7.5	12	7	12	
$t_{f>LH}$	Select A/B		9.5	15	8	12	ns
$t_{f>HL}$	Select A/B		9.5	15	8	12	

t_{PLH} - propagation delay time, low-to-high-level output

t_{PHL} - propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section

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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
76002012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7600201EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7600201EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7600201FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
7600201FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
76033012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
76033012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7603301EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7603301EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7603301FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
7603301FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/07903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/07903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07904BEA	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
JM38510/07904BFA	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI
JM38510/30903B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30903B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/30903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SN54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S158J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN54S15J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74157N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74157N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74157N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74157N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LS157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS157N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
						no Sb/Br)		
SN74LS158DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS158N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS158NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S157N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
SN74S158D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74S158D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74S158DR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74S158DR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74S158N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SNJ54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS158FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS158FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS158W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS158W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S158FK	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S158J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SNJ54S158W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI
SNJ54S15FK	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S15J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ54S15W	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

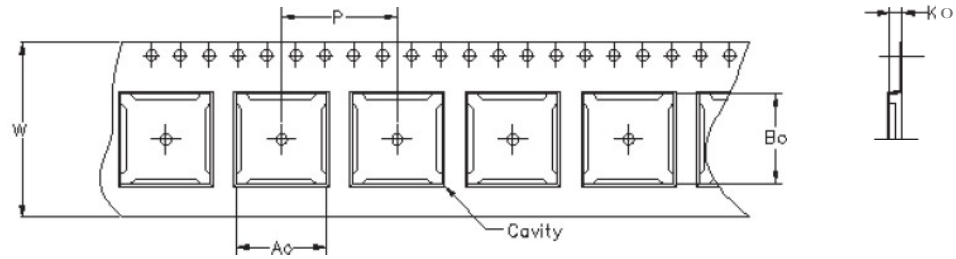
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

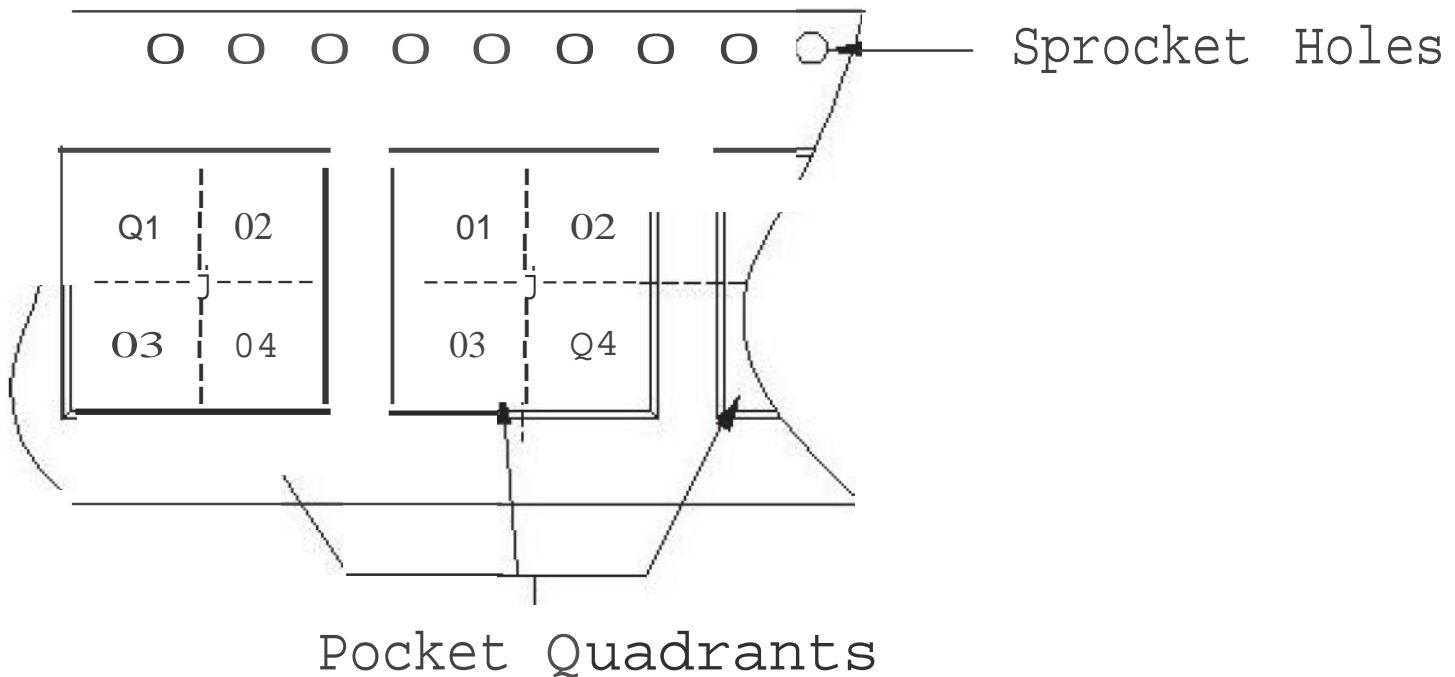
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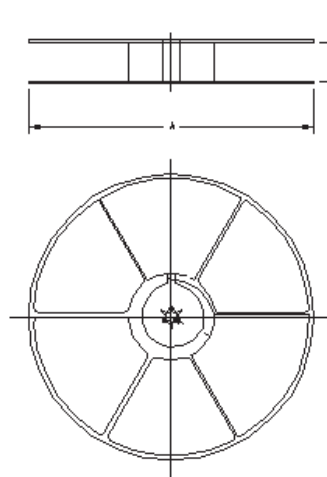
Carrier tape design is defined largely by the component length, width, and thickness.

A ₀ = Dimension designed to accommodate the component width.
B ₀ = Dimension designed to accommodate the component length.
K ₀ = Dimension designed to accommodate the component thickness.
W = Overall width of the carrier tape.
P = Pitch between successive cavity centers.



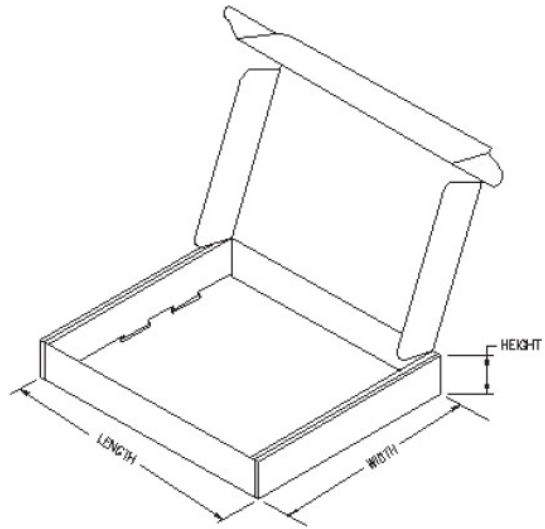
TAPE AND REEL INFORMATION

Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS157DR	D	16	FMX	330	16	6.5	10.3	2.1	8	16	Q1
SN74LS157NSR	NS	16	MLA	330	16	8.2	10.5	2.5	12	16	Q1
SN74LS158DR	D	16	FMX	330	16	6.5	10.3	2.1	8	16	Q1
SN74LS158NSR	NS	16	MLA	330	16	8.2	10.5	2.5	12	16	Q1
SN74S157NSR	NS	16	MLA	330	16	8.2	10.5	2.5	12	16	Q1



TAPE AND REEL BOX INFORMATION

Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
SN74LS157DR	D	16	FMX	342.9	336.6	28.58
SN74LS157NSR	NS	16	MLA	342.9	336.6	28.58
SN74LS158DR	D	16	FMX	342.9	336.6	28.58
SN74LS158NSR	NS	16	MLA	342.9	336.6	28.58
SN74S157NSR	NS	16	MLA	342.9	336.6	28.58



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
76002012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
76002012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7600201EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7600201EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7600201FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
7600201FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
76033012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
76033012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7603301EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7603301EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7603301FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
7603301FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/07903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/07903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07904BEA	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
JM38510/07904BFA	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI
JM38510/30903B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30903B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/30903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SN54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S158J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN54S15J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74157N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74157N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74157N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74157N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LS157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS157N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
						no Sb/Br)		
SN74LS158DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS158N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS158NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S157N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
						no Sb/Br)		
SN74S157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S158D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74S158D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74S158DR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74S158DR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74S158N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SNJ54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS158FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS158FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS158W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS158W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S158FK	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S158J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SNJ54S158W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI
SNJ54S15FK	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S15J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ54S15W	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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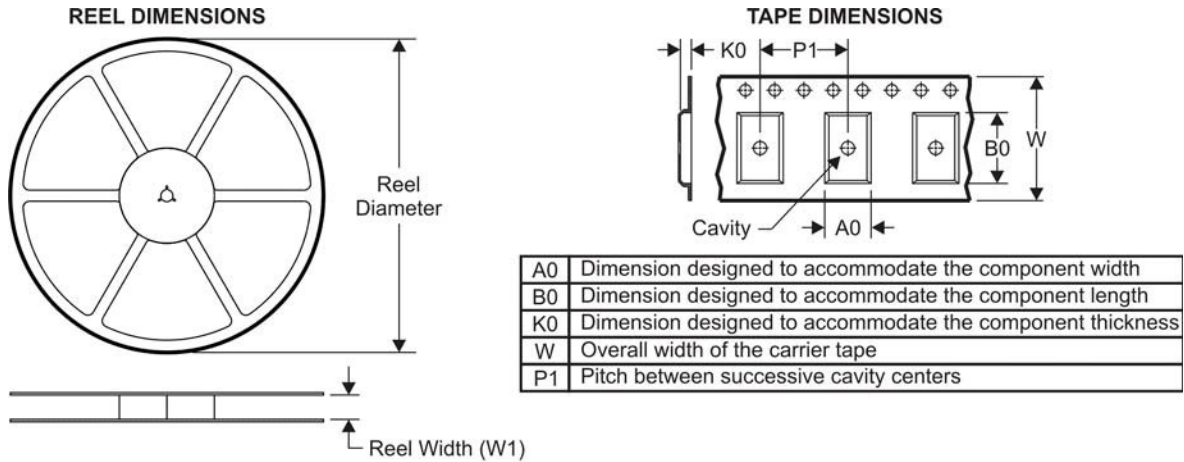
OTHER QUALIFIED VERSIONS OF SN54157, SN54LS157, SN54LS158, SN54S15, SN54S157, SN54S158, SN74157, SN74LS157, SN74LS158, SN74S157, SN74S158 :

● Catalog: [SN74S15](#)

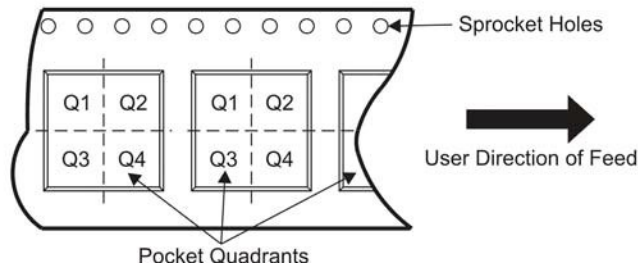
NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION



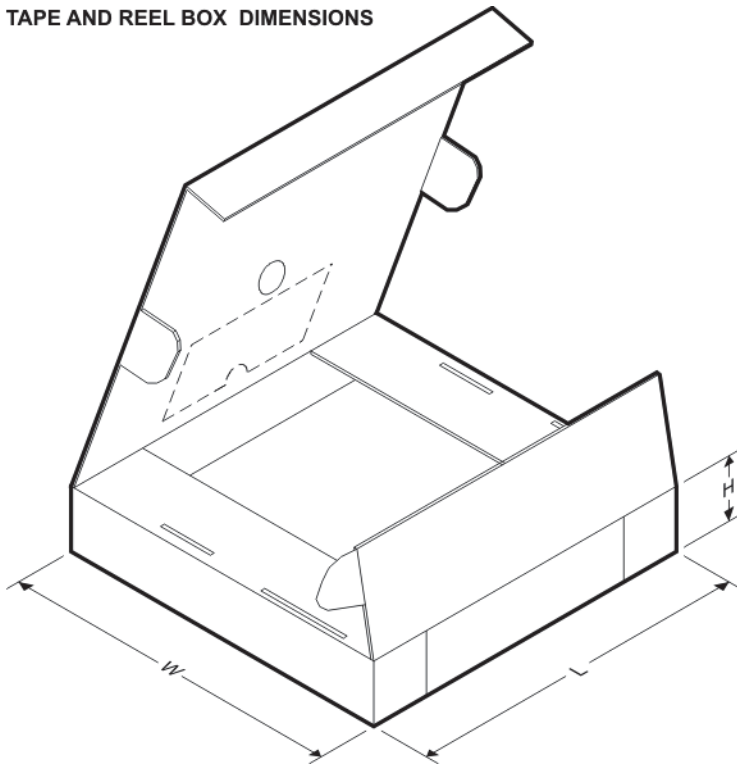
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS157DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS157NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LS158DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS158NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74S157NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



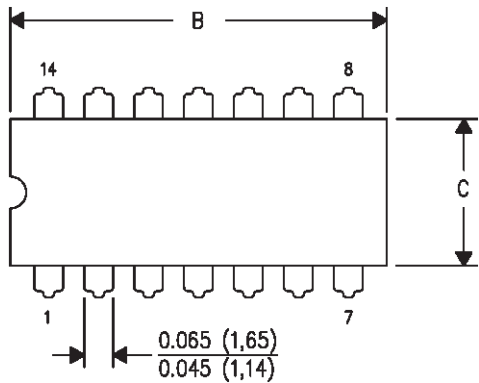
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS157DR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS157NSR	SO	NS	16	2000	346.0	346.0	33.0
SN74LS158DR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS158NSR	SO	NS	16	2000	346.0	346.0	33.0
SN74S157NSR	SO	NS	16	2000	346.0	346.0	33.0

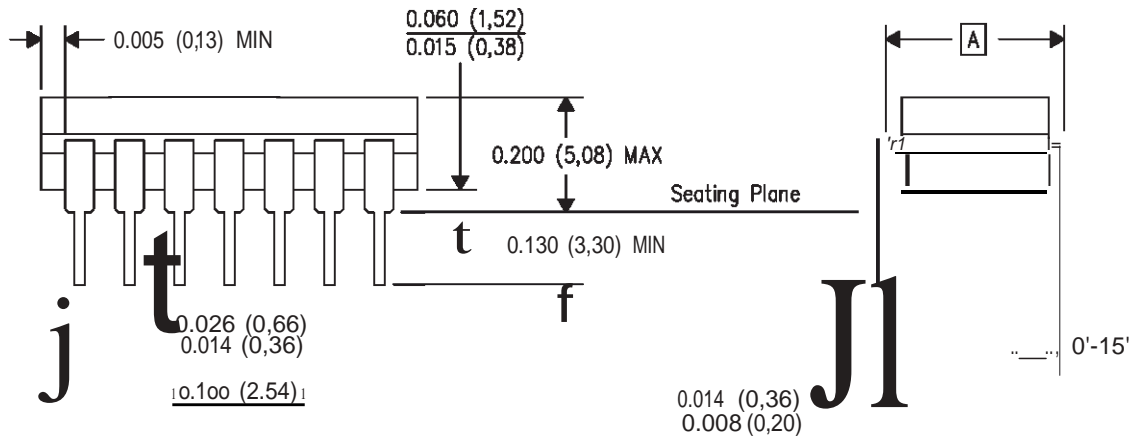
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



M	14	16	18	20
	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



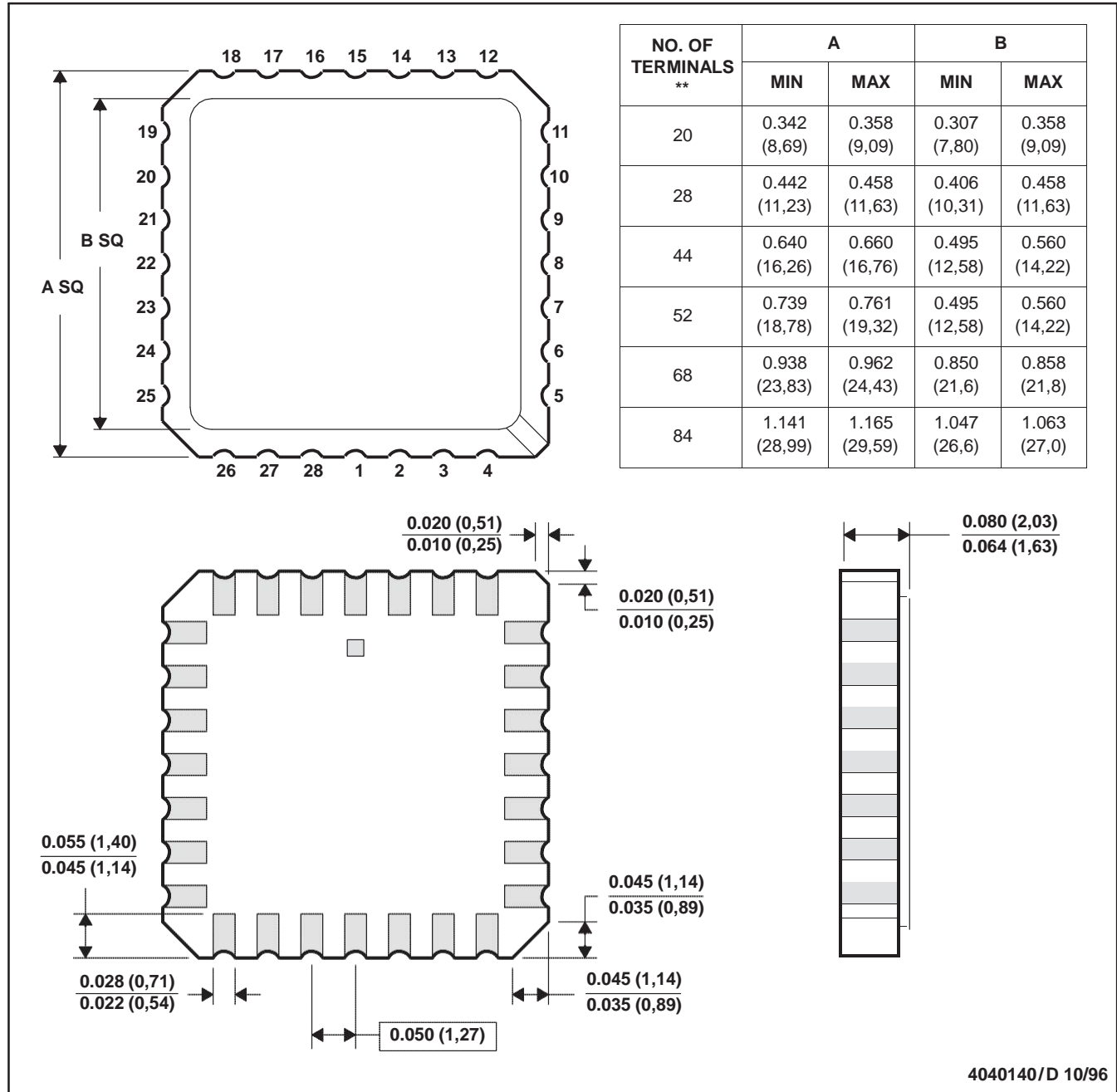
4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package is hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - Falls within MIL SID 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN

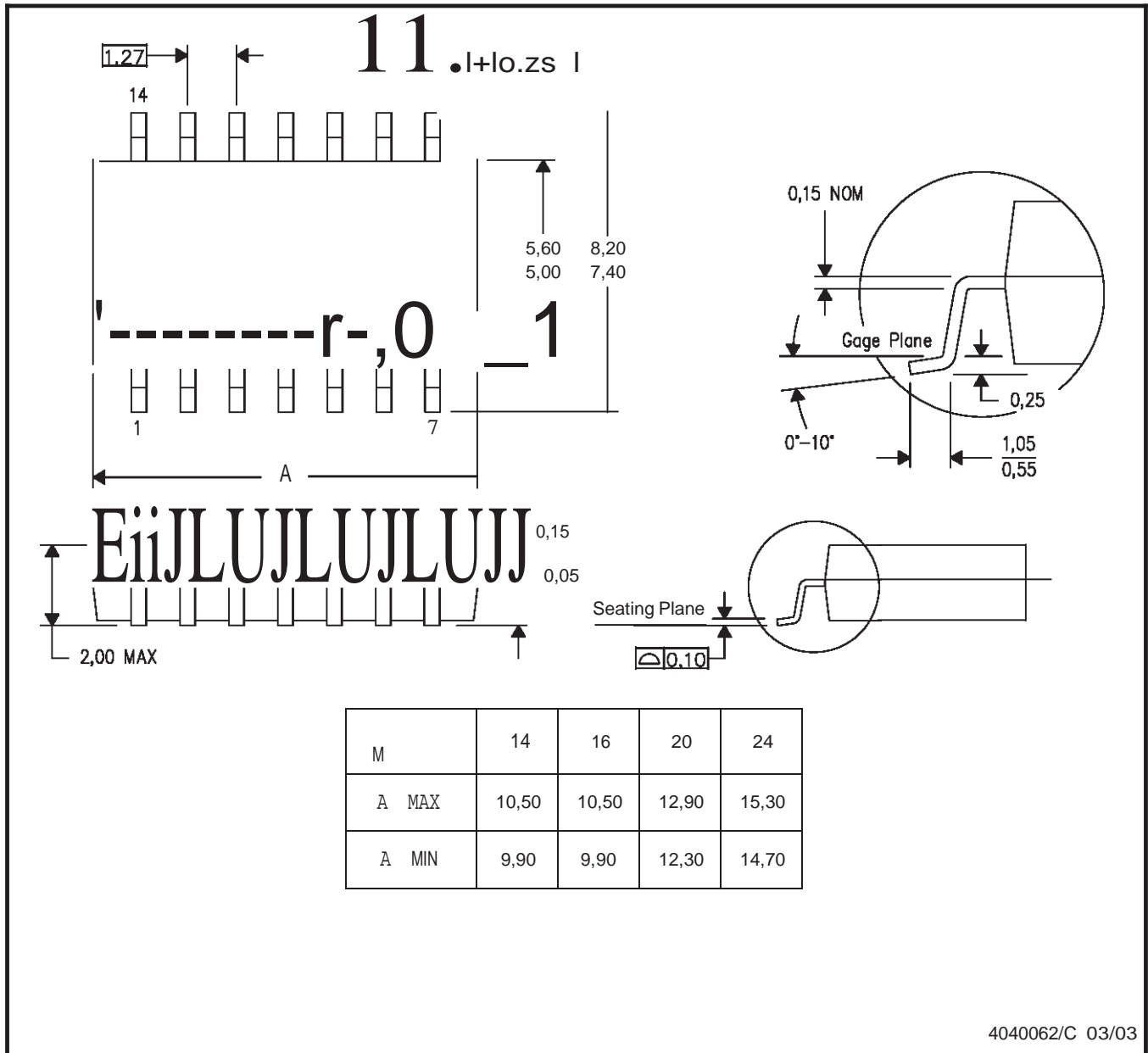


- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a metal lid.
 D. The terminals are gold plated.
 E. Falls within JEDEC MS-004

MECHANICAL DATA

NS(R-PDSO-G.,
14-PINS SHOWN

PLASTIC SMAU.-OUTUNE PACKAGE

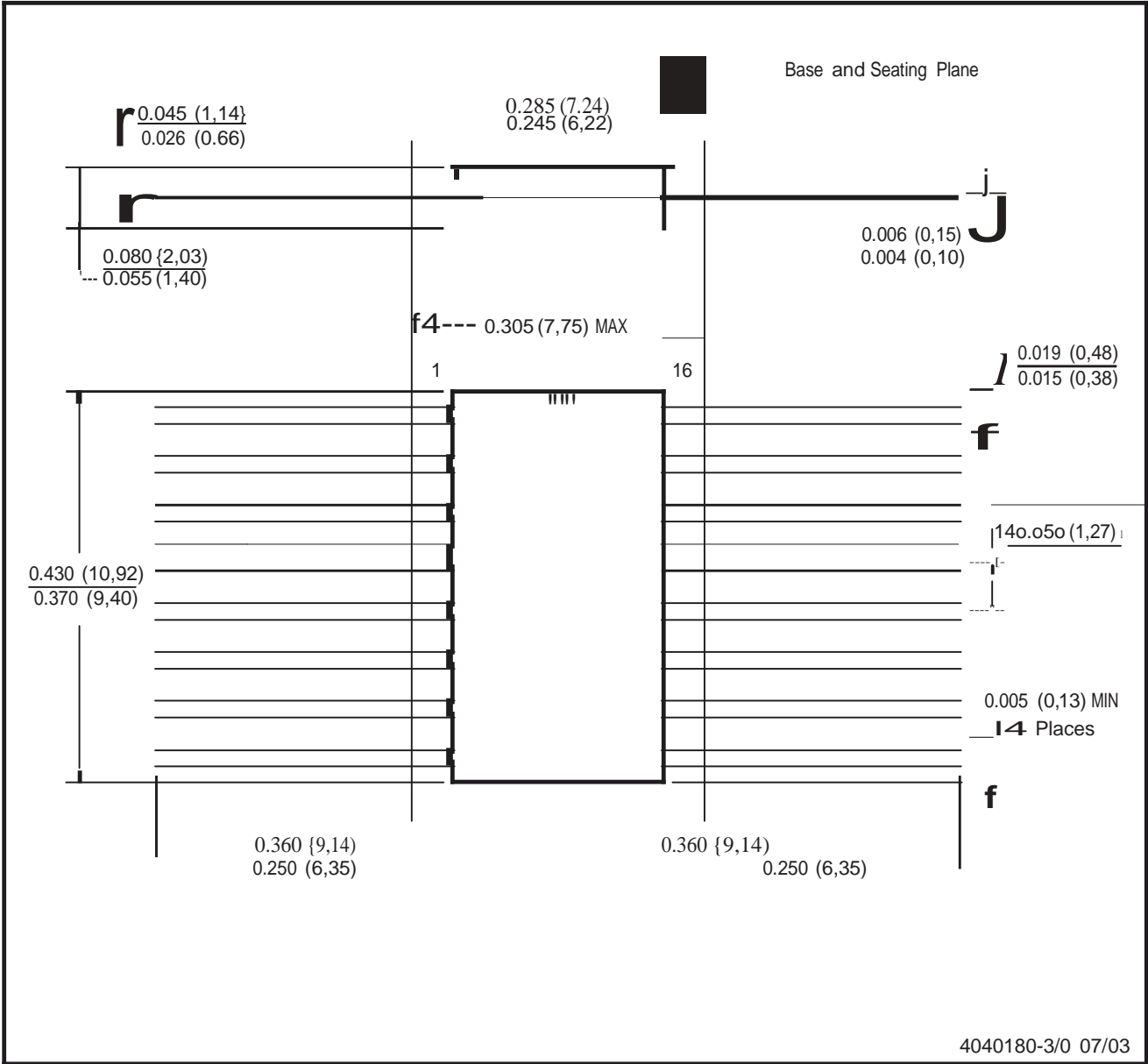


4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

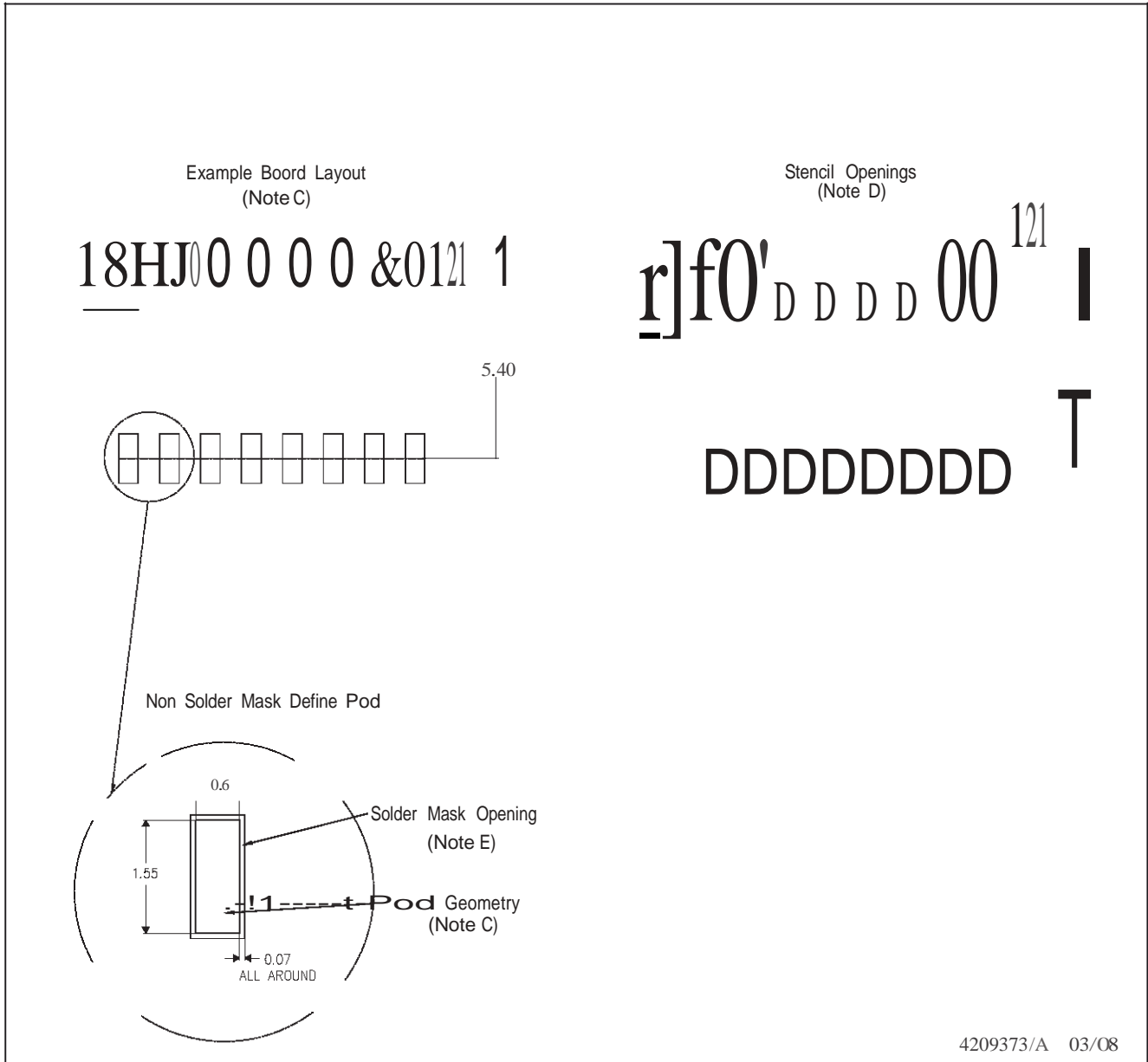
W (R-GDFP-F16)

CERAMIC DUAL FLAIPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC M0-092AC

D(R-PDSO-G16)

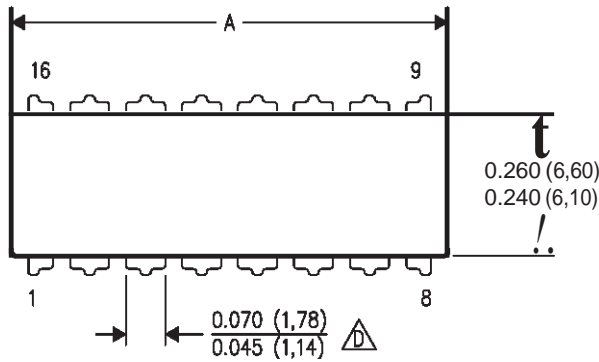


- N01ES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Refer to IPC7351 for alternate board design.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

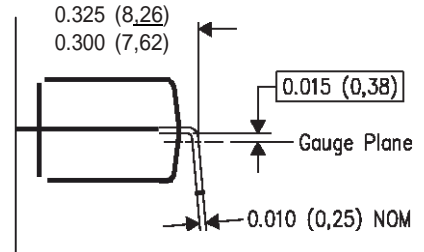
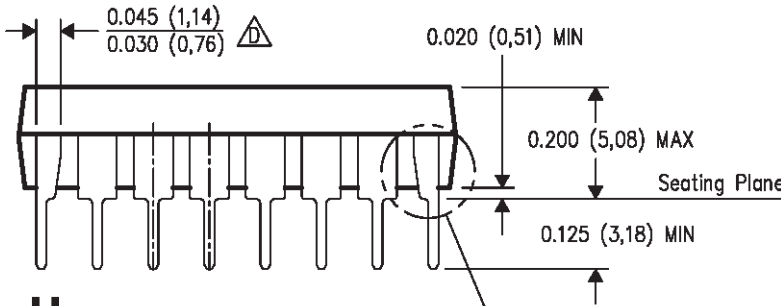
N (R-PDIP-T)**

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

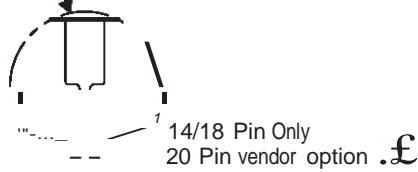


M	14	16	18	20
A tMAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIA110N	AA	BB	AC	AD



JL
 0.021 (0,53)
 0.015 (0,38)
 I-\$-10.010 (0,25)@1

J 0.430 (10,92) tMAX **1.-**



14/18 Pin Only
 20 Pin vendor option .£

4040049/E 12/2002

- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
Lfu. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

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